

HCG75FH170A11

1700V/75A Half Bridge IGBT Module

Description

The HCG75FH170A11 offer lower losses and higher energy for soft switching applications.



Features

- 1700V 75A, $V_{CE(sat)}(typ.) = 2.40V$
- Lower losses and higher energy
- Excellent short-circuit capability
- 34 mm half bridge module

Applications

- Motor drive
- Inverter
- Power supply
- Wind Turbines

Circuit diagram

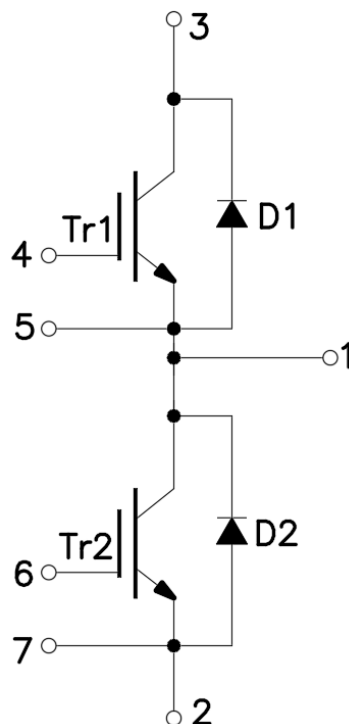


Figure 1. Out drawing & circuit diagram for HCG75FH170A11

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Pin Configuration and Marking Information

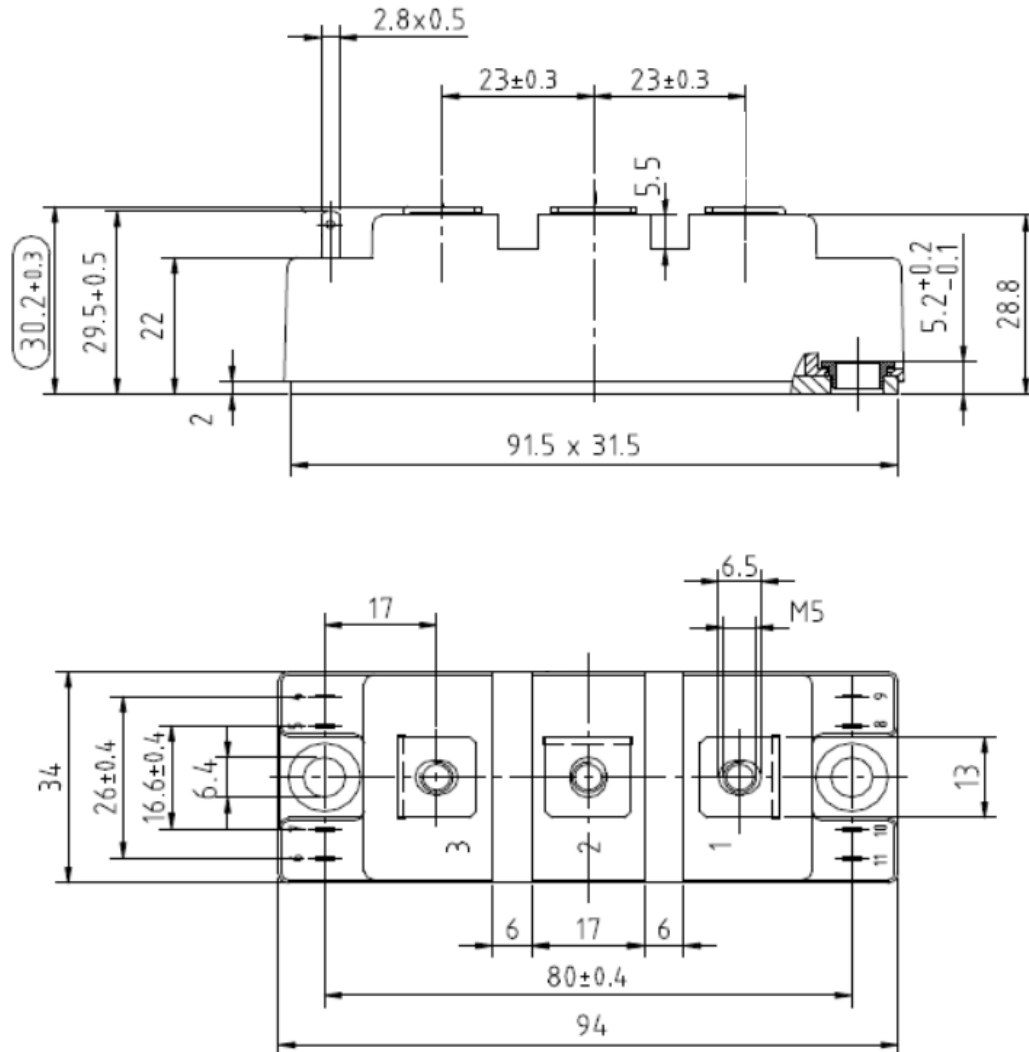


Figure 2. Pin configuration

Module

Parameter	Conditions	Value	Unit
Isolation Voltage	RMS, f = 50Hz, t = 1min	2.5	KV
Material of module baseplate	-	Cu	-
Creepage distance	terminal to heatsink terminal to terminal	26 21	mm
Clearance	terminal to heatsink terminal to terminal	23.6 10	mm
CTI	-	>200	-
Module lead resistance, terminals – chip	T _c = 25°C	0.8	mΩ
Mounting torque for module mounting	M5, M6	3 to 6	Nm
Weight	-	160	g

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Maximum Ratings (IGBT, $T_j=25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
V_{CES}	Collector-Emitter Voltage	G-E Short	1700	V
V_{GES}	Gate-Emitter Voltage	C-E Short	$\pm 30\text{V}$	V
I_C	DC Continuous Collector Current	$T_C=100^{\circ}\text{C}$	75	A
I_{CM}	Pulse Collector Current	$t_p=1\text{ms}$, Note1	150	A
P_C	Maximum Power Dissipation	$T_C=25^{\circ}\text{C}$, $T_j=150^{\circ}\text{C}$ (IGBT)	450	W
T_{jop}	junction temperature	-	-40 to 150	$^{\circ}\text{C}$
T_{stg}	Storage temperature	-	-40 to 125	$^{\circ}\text{C}$

Note1: Pulse width limited by maximum junction temperature

Maximum Ratings (Freewheeling diode, $T_j=25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
V_{RRM}	Peak Repetitive Revers Voltage	-	1700	V
I_F	Diode forward Current	- $T_C=100^{\circ}\text{C}$	75	A
I_{FRM}	Repetitive peak forward Current	$t_p=1\text{ms}$, Note1	150	A
T_{jop}	junction temperature	-	-40 to 150	$^{\circ}\text{C}$
T_{stg}	Storage temperature	-	-40 to 125	$^{\circ}\text{C}$

Note1: Pulse width limited by maximum junction temperature

IGBT Electrical characteristics ($T_j=25^{\circ}\text{C}$ unless otherwise specified, chip)

Symbol	Item	Condition		Value			Unit
				Min.	Typ.	Max	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=75A$	$T_j=25^{\circ}C$	-	2.40	-	V
		$V_{GE}=15V$	$T_j=125^{\circ}C$	-	2.70	-	V
$V_{GE(th)}$	Gate-Emitter threshold Voltage	$I_C=1mA, V_{CE}=V_{GE}$		4.5	-	5.7	V
Q_G	Gate charge	$V_{GE} = -15V \text{ to } +15V$		-	800	-	nC
R_{Gint}	Internal gate resistor	$f=1M, V_{pp}=1V$	$T_j=25^{\circ}C$	-	5.6	-	Ω
C_{ies}	Input Capacitance	$V_{CE}=25V, V_{GE}=0V$	$T_j=25^{\circ}C$	-	6	-	nF
C_{oes}	Output Capacitance	$f=1MHz$		-	0.8	-	nF
C_{res}	Reverse transfer Capacitance			-	0.5	-	nF
I_{CES}	Collector- Emitter Cut off Current	$V_{CE}=1700V, V_{GE}=0V$	$T_j=25^{\circ}C$	-	-	5	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE} = \pm 30V, V_{CE}=0V$	$T_j=25^{\circ}C$	-	-	400	nA
$t_{d(on)}$	Turn-on delay time	$V_{CC} = 900V$ $I_C = 75A$ $R_G = 6.2\Omega$ $V_{GE} = \pm 15V$ Inductive Load	$T_j=25^{\circ}C$	-	140	-	ns
			$T_j=125^{\circ}C$	-	150	-	
t_r	Rise time		$T_j=25^{\circ}C$	-	50	-	ns
			$T_j=125^{\circ}C$	-	45	-	
$t_{d(off)}$	Turn-off delay time		$T_j=25^{\circ}C$	-	300	-	ns
			$T_j=125^{\circ}C$	-	320	-	

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t_f	Fall time	$V_{CC} = 900V$ $I_C = 75A$	$T_j = 25^\circ C$	-	310	-	ns
			$T_j = 125^\circ C$	-	480	-	
E_{on}	Turn-on power dissipation	$R_G = 6.2\Omega$ $V_{GE} = \pm 15V$	$T_j = 25^\circ C$	-	11	-	mJ
			$T_j = 125^\circ C$	-	14	-	
E_{off}	Turn-off power dissipation	Inductive Load	$T_j = 25^\circ C$	-	9	-	mJ
			$T_j = 125^\circ C$	-	15	-	
$R_{th(j-c)}$	Thermal Resistance, Junction to Case (IGBT)			-		0.33	$^\circ C/W$

Freewheeling Diode Electrical characteristics ($T_j = 25^\circ C$ unless otherwise specified, chip)

Symbol	Item	Condition		Value			Unit
				Min.	Typ.	Max	
V _F	Diode Forward Voltage	I _F = 75A, V _{GE} = 0V	T _J = 25°C	-	2.6	-	V
			T _J = 125°C	-	2.75	-	
t _{rr}	Diode Reverse Recovery Time	I _F = 75A, di/dt = 2100A/μs, V _R = 900V, V _{GE} = -15V	T _J = 25°C		90		nS
			T _J = 125°C		200		
I _{rr}	Peak reverse recovery Current		T _J = 25°C	-	80	-	A
			T _J = 125°C	-	85	-	
Q _{rr}	Recovered charge		T _J = 25°C	-	4	-	uC
			T _J = 125°C	-	9	-	
E _{rr}	Reverse recovered energy		T _J = 25°C	-	2.7	-	mJ
			T _J = 125°C	-	4.2	-	
R _{th(j-c)}	Thermal Resistance, Junction to Case (Diode)			-		0.3	°C/W

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Test Conditions

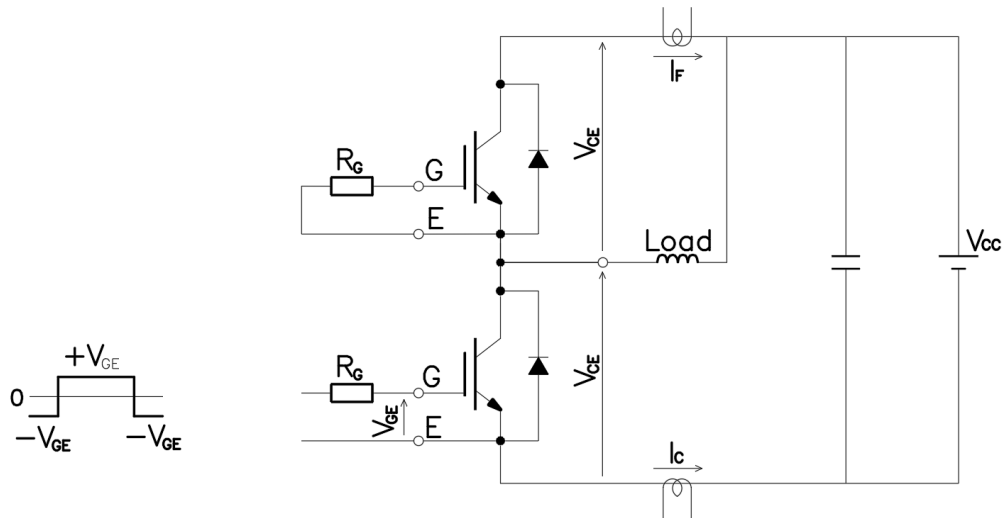


Figure 3. Switching time measure circuit

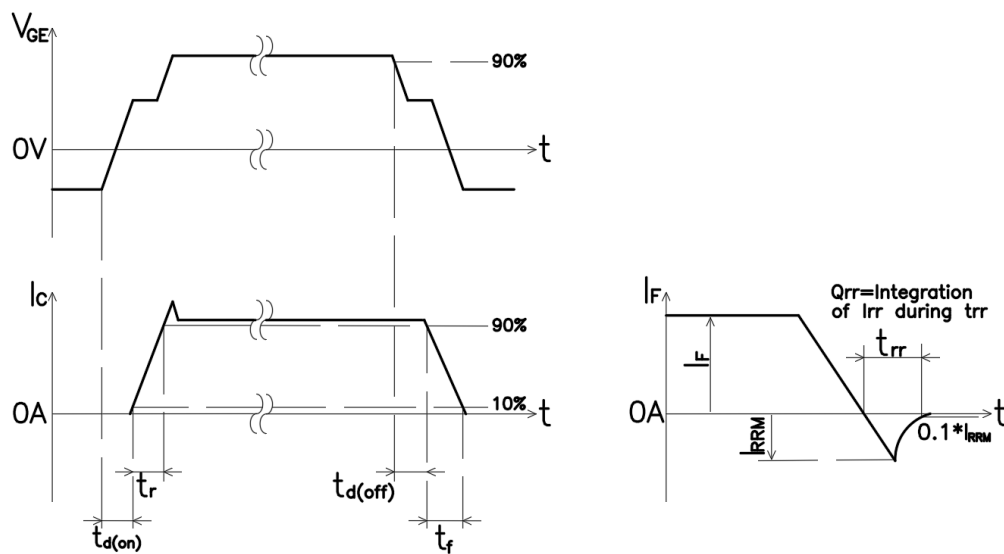


Figure 4. Switching time definition

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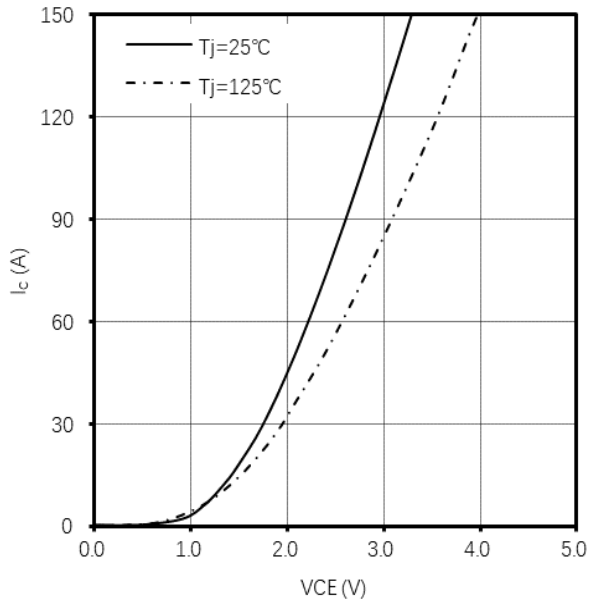


Figure 5. I_c vs V_{CE}
 $V_{GE} = 15\text{V}$

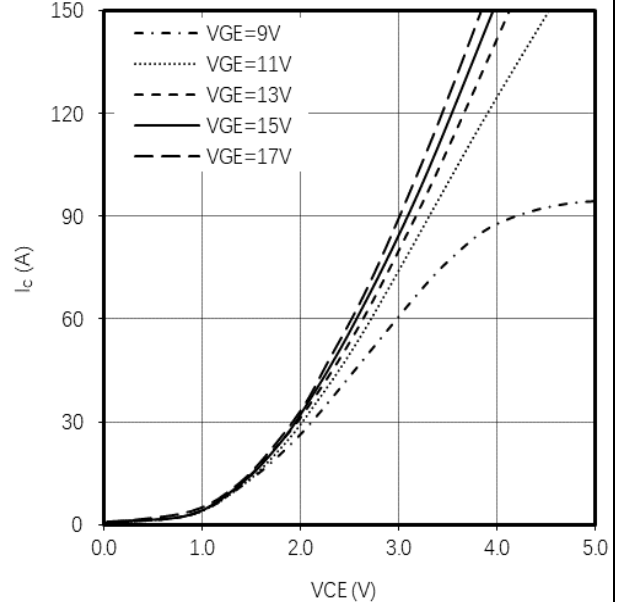


Figure 6. I_c vs V_{CE}
 $T_j = 125^\circ\text{C}$

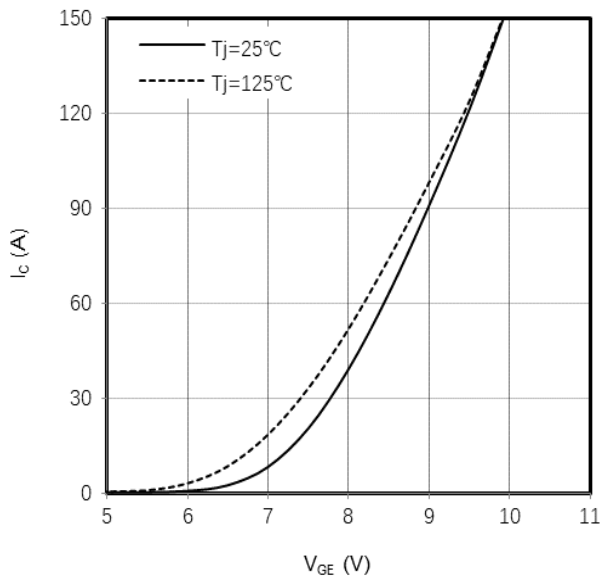


Figure 7. I_c vs V_{GE}
 $V_{CE} = 20\text{V}$

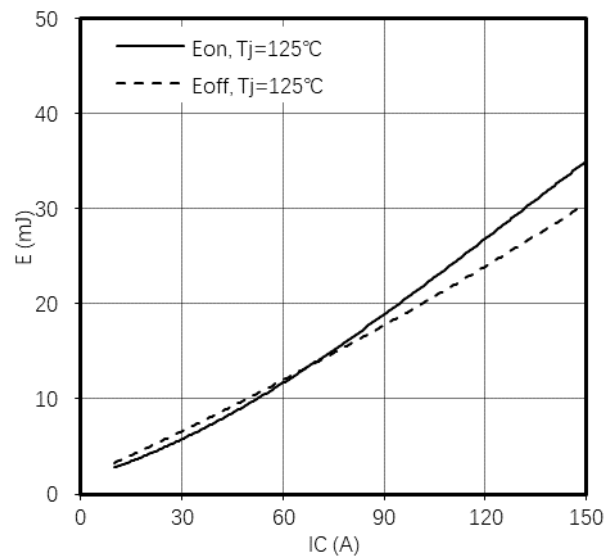


Figure 8. E_{on}, E_{off} vs I_c (Typ)
 $V_{CC} = 900\text{V}$, $V_{GE} = +15\text{V}/-15\text{V}$, $R_G = 6.2\Omega$

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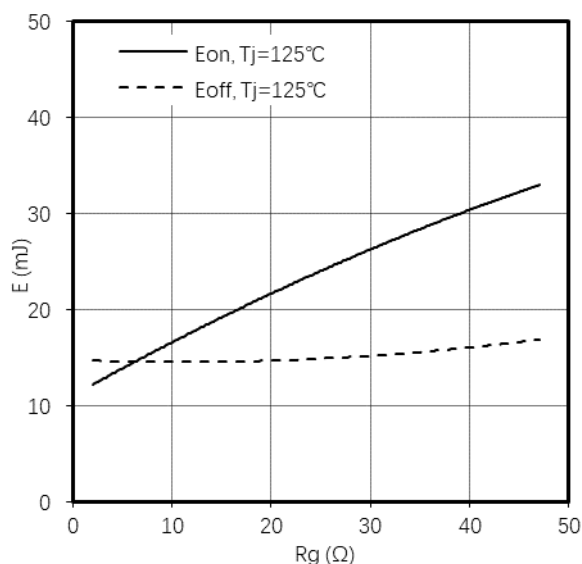


Figure 9. E_{on} , E_{off} vs R_g (Typ)
 $V_{CC}=900V$, $V_{GE}=+15V/-15V$, $I_C=75A$

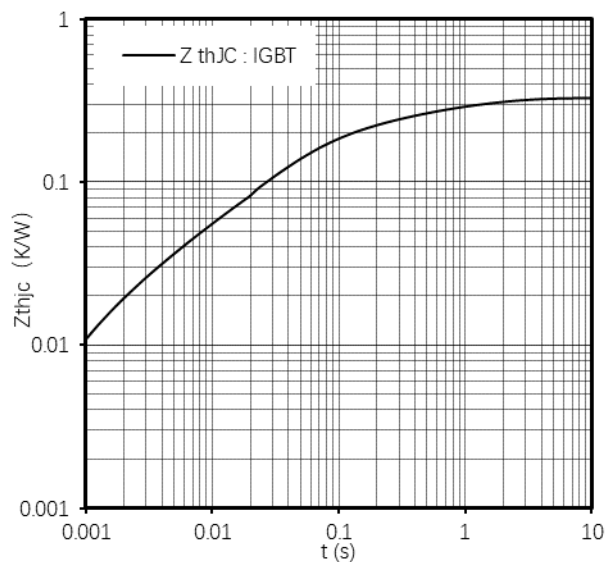


Figure 10. Transient thermal impedance IGBT ,
 $Z_{thjc}=f(t)$

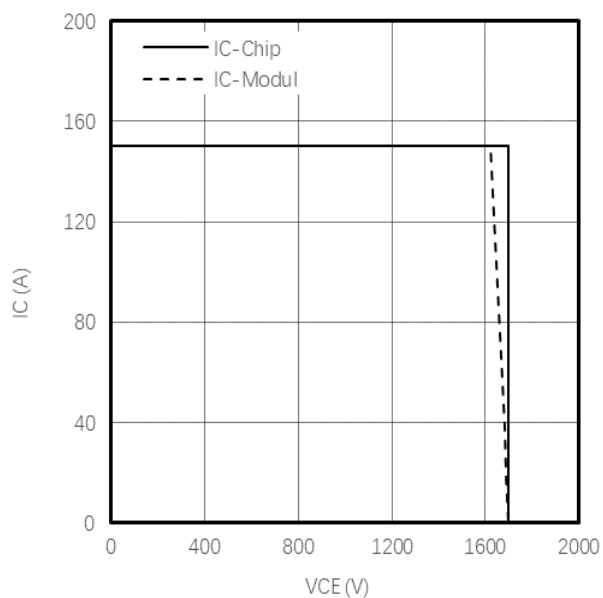


Figure 11. Reverse bias safe operating area IGBT,
 $I_C=f(V_{CE})$, $V_{GE}=\pm 15V$, $R_{Goff}=6.2\Omega$, $T_{vj}=125^\circ C$

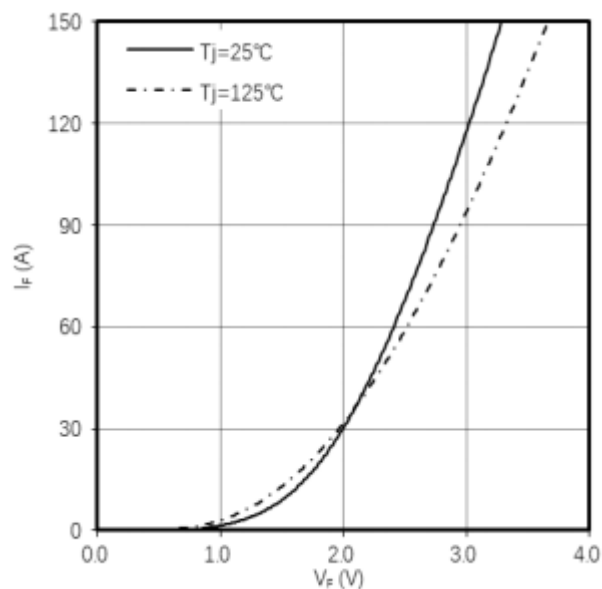


Figure 12. Forward characteristic of Diode ,
 $I_F=f(V_F)$

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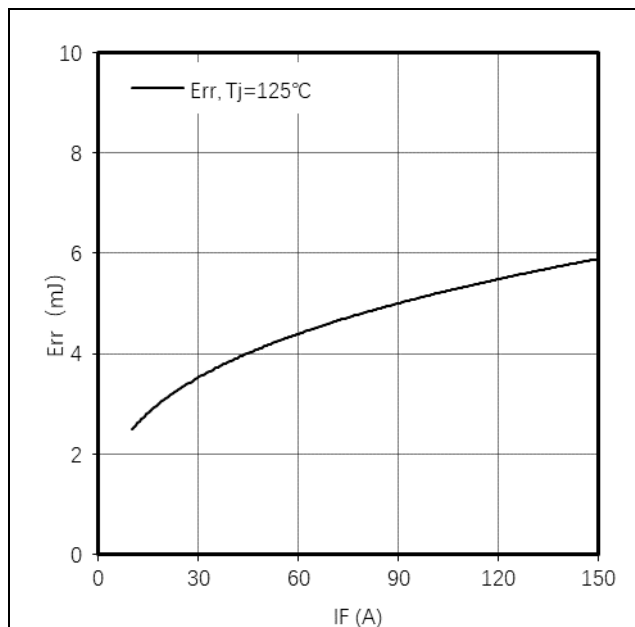


Figure 13. Switching losses Diode,
 $E_{rr}=f(I_F)$, $R_{Gon}=6.2\Omega$, $V_{CE}=900V$

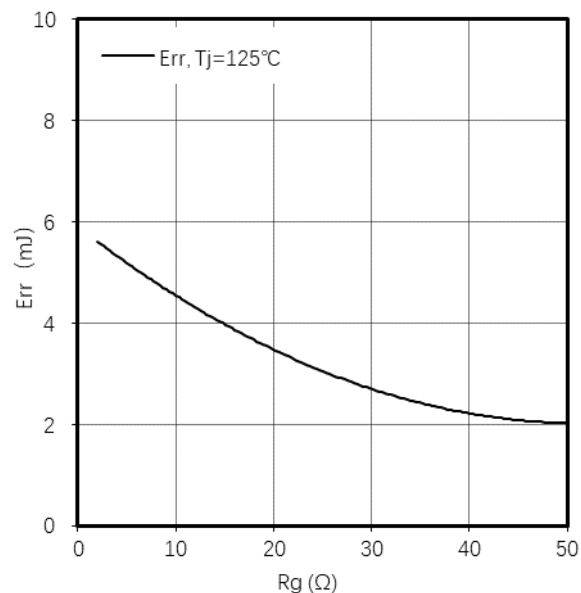


Figure 14. Switching losses Diode,
 $E_{rr}=f(R_G)$, $I_F=75A$, $V_{CE}=900V$

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The data contained in this document is exclusively intended for technically trained staff. You and your technical departments will have to evaluate the product's suitability for the intended application and the completeness of the product data concerning such application.

Due to technical requirements, our product may contain dangerous substances. For information on the types in question, please contact the sales staff responsible for you.

Changes to this product data sheet are reserved.

Please contact the sales staff (Email:sales@hiitio.com) for further information on the product, technology, delivery terms, conditions and prices.

Revision History

Document Version	Description of Changes
RevX.0.1	Released

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